Features

- Trench MV MOSFET Technology
- Moisture Sensitivity Level 1
- Halogen Free. “Green” Device (Note 1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

P-Channel Power MOSFET

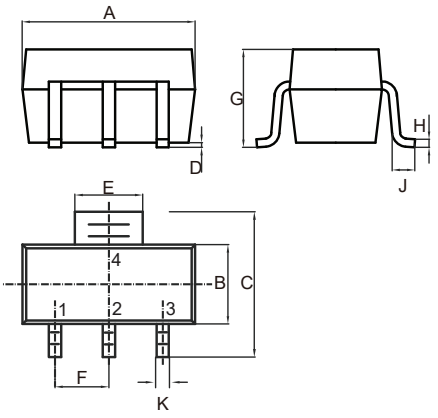
Maximum Ratings

- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance:60°C/W Junction to Ambient(Note2)

Parameter		Symbol	Rating	Unit
Drain-Source Voltage		V_{DS}	-100	V
Gate-Source Volltage		V_{GS}	±20	V
Continuous Drain Current	T_A=25°C	I_D	-6	A
	T_A=100°C		-3.8	
Pulsed Drain Current (Note 3)		I_{DM}	- 24	A
Total Power Dissipation(Note4)		P_D	2.1	W

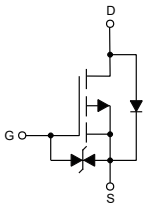
Note:
1. Halogen free "Green” products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. The value of $R_{\theta JA}$ is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C.
3. Repetitive rating; pulse width limited by max. junction temperature.
4. P_D is based on max. junction temperature, using junction-ambient thermal resistance.

SOT-223



DIMENSIONS					
DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.248	0.264	6.30	6.70	
B	0.130	0.146	3.30	3.70	
C	0.264	0.287	6.70	7.30	
D	0.001	0.004	0.02	0.10	
E	0.114	0.122	2.90	3.10	
F	0.091		2.30		TYP.
G	---	0.071	---	1.80	
H	0.009	0.014	0.23	0.35	
J	0.030	---	0.75	---	
K	0.026	0.033	0.66	0.84	

Internal Structure and Marking Code



1. GATE
2. DRAIN
3. SOURCE
4. DRAIN

Electrical Characteristics @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS}=0V, I_D=-250μA	-100			V
Gate-Source Leakage Current	I_{GSS}	V_{DS}=0V, V_{GS} =±16V			±10	μA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=-100V, V_{GS}=0V			-1	
Gate-Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS}, I_D=-250μA	-1.2	-1.7	-2.8	V
Drain-Source On-Resistance	$R_{DS(on)}$	V_{GS}=-10V, I_D=-6A		168	205	mΩ
		V_{GS}=-4.5V, I_D=-6A		182	250	
Gate Resistance	R_g	f=1 MHz, Open drain		5		Ω
Diode Characteristics						
Continuous Body Diode Current	I_S				-6	A
Diode Forward Voltage	V_{SD}	V_{GS}=0V, I_S=-6A			-1.2	V
Reverse Recovery Time	t_{rr}	I_F=-6A, dI_F/dt=100A/μs		40		ns
Reverse Recovery Charge	Q_{rr}			95		nC
Dynamic Characteristics						
Input Capacitance	C_{iss}	V_{DS}=-25V,V_{GS}=0V,f=1MHz		1707		pF
Output Capacitance	C_{oss}			64		
Reverse Transfer Capacitance	C_{rss}			60		
Total Gate Charge	Q_g	V_{DS}=-50V,V_{GS}=-10V,I_D=-6A		35		nC
Gate-Source Charge	Q_{gs}			2.7		
Gate-Drain Charge	Q_{gd}			4.2		
Turn-On Delay Time	$t_{d(on)}$	V_{DD}=-50V,V_{GS}=-10V, R_{GEN}=9.1Ω, I_D=-6A		10		ns
Turn-On Rise Time	t_r			38		
Turn-Off Delay Time	$t_{d(off)}$			78		
Turn-Off Fall Time	t_f			32		

Curve Characteristics

Fig.1 - Typical Output Characteristics

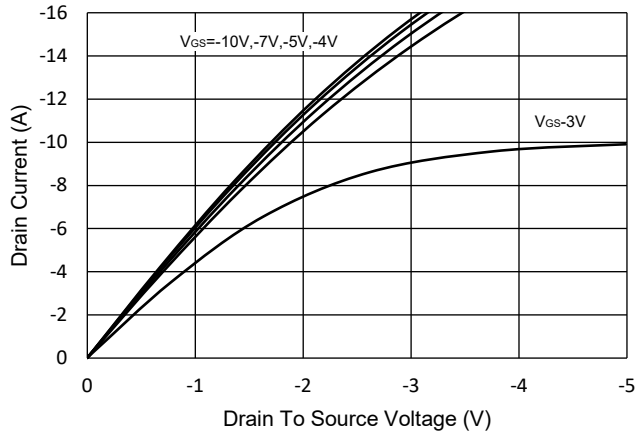


Fig.2 - Transfer Characteristic

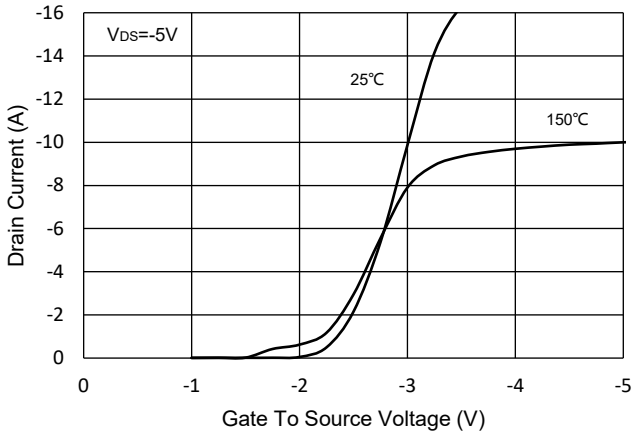


Fig.3 - $R_{DS(ON)}$ - V_{GS}

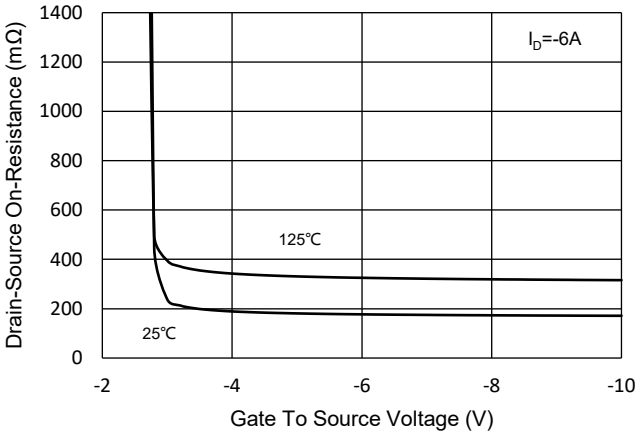


Fig.4 - $R_{DS(ON)}$ - I_D

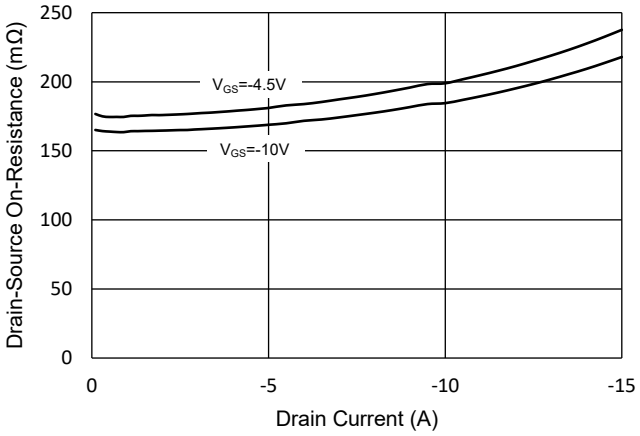


Fig.5 - Capacitance Characteristics

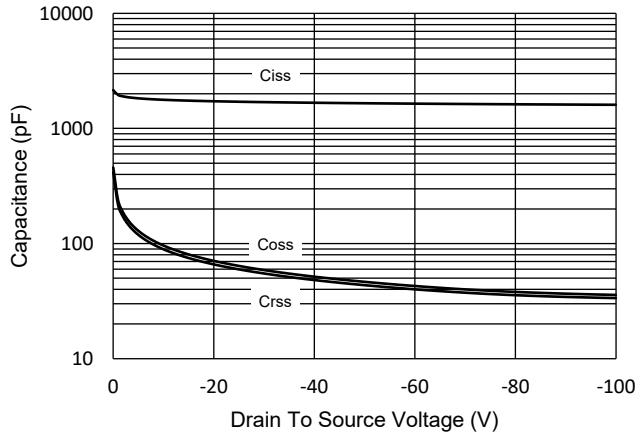
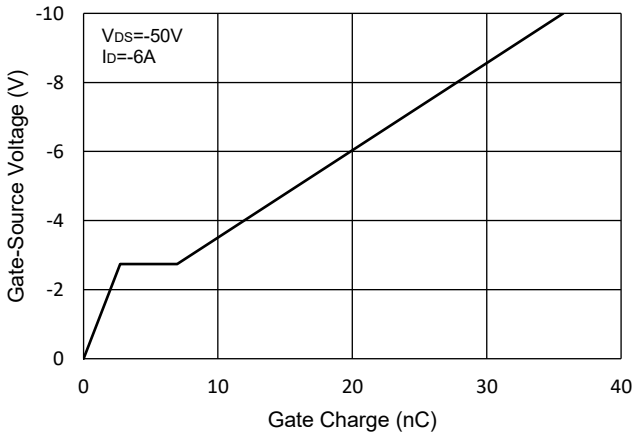


Fig.6 - Gate Charge



Curve Characteristics

Fig.7 - Normalized Threshold Voltage

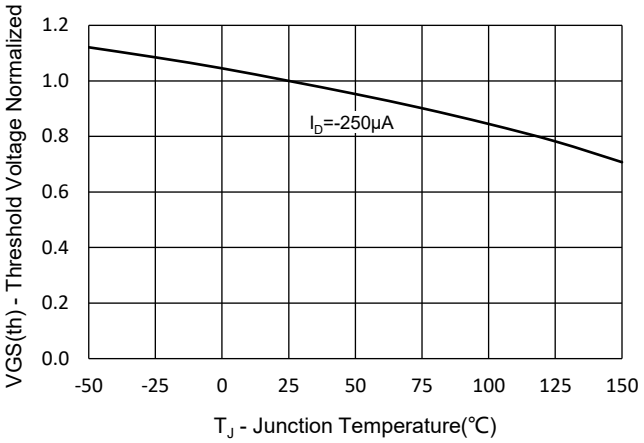


Fig.8 - Normalized On Resistance Characteristics

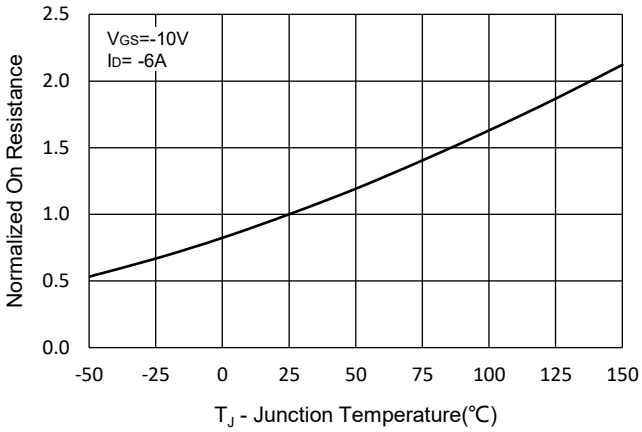


Fig.9 - I_S - V_{SD}

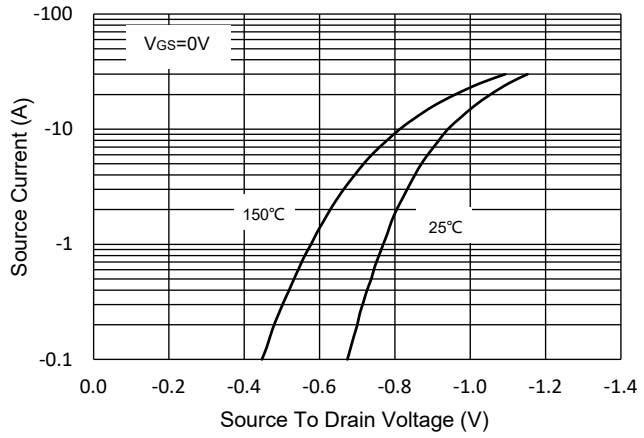


Fig.10 - Drain Current

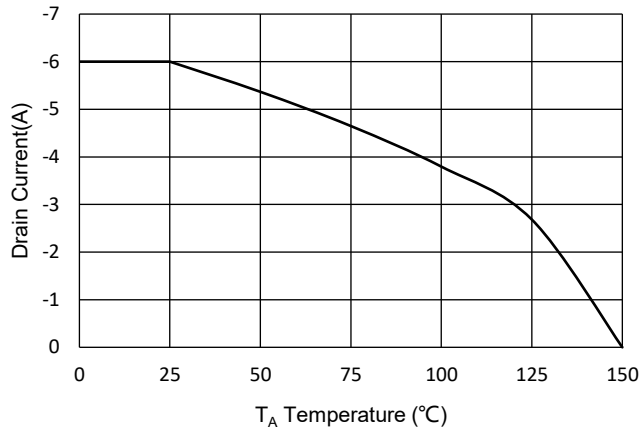
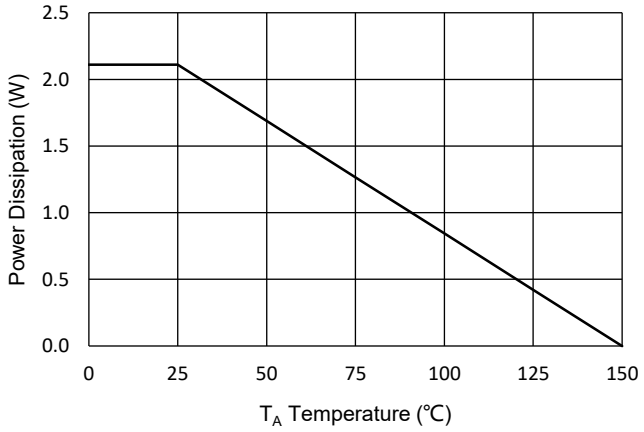


Fig.11 - PD Dissipation



Curve Characteristics

Fig.12 - Safe Operation Area

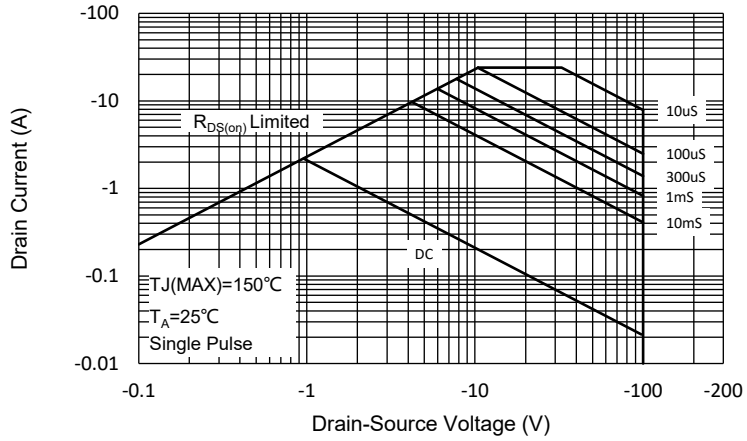
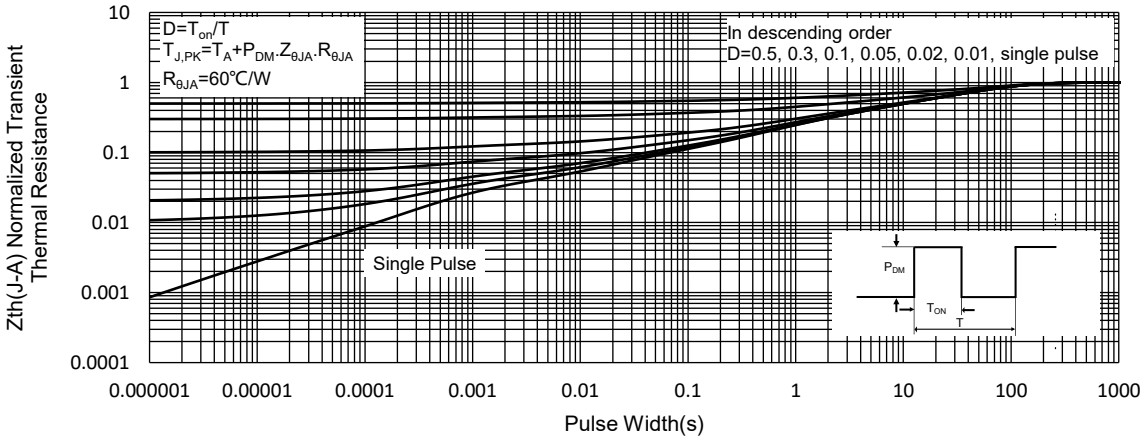


Fig.13 - Normalized Transient Thermal Impedance



Ordering Information

Device	Packing
Part Number-TP	Tape&Reel: 2.5Kpcs/Reel